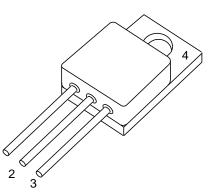


HiRel RadHard Power-MOS

- Low R_{DS(on)}
- Total Ionisation Dose (TID) hardened 100 kRad approved
- Hermetically sealed
- N-channel



Туре	Marking	Pin Co	Package			
		1	2	3	4	
BUY25CS45B-01	-	D	S	G	Not connected	TO-254AA

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain Source Voltage	V _{DS}	250	V
Gate Source Voltage	V _{GS}	+/- 20	V
Drain Gate Voltage	V_{DG}	250	V
Continuous Drain Current $T_c = 25 \ ^{\circ}C$ $T_c = 100 \ ^{\circ}C$	I _D	45 29	A
Continuous Source Current	Is	45	А
Drain Current Pulsed, t_p limited by T_{jmax}	I _{DM}	180	Apk
Total Power Dissipation 1)	P _{tot}	208	W
Junction Temperature	TJ	-55 to + 150	°C
Operating and Storage Temperature	T _{op}	-55 to + 150	°C
Avalanche Energy	E _{AS}	380	mJ

Thermal Characteristics

Thermal Resistance (Junction to Case)	R _{th JC}	0.6	K/W
Soldering Temperature	T _{sol}	250	°C

Notes .:

1) For $T_S \le 25^{\circ}$ C. For $T_S > 25^{\circ}$ C derating is required.



Data Sheet BUY25CS45B-01

Electrical Characteristics, at T_A=25°C; unless otherwise specified

Parameter	Symbol		Values	Unit	
		min.	typ.	max.	
DC Characteristics	1	ł	•		
Breakdown Voltage Drain to Source $I_D = 0.25 \text{mA}, V_{GS} = 0 \text{V}$	B _{VDSS}	250	-	-	V
Gate Threshold Voltage I _D = 1.0mA, V _{DS} ≥ V _{GS}	$V_{GS(th)}$	2.0	-	4.0	V
Gate to Source Leakage Current V _{DS} = 0V, V _{GS} = +/- 20V	I _{GSS}	-	-	+/-100	nA
Drain Current V _{DS} = 200V, V _{GS} = 0V	I _{DSS}	-	-	25	μA
Drain Source On Resistance ¹⁾ $V_{GS} = 10V, I_D = 29A$	r _{DS(ON)}	-	-	0.05	Ω
Source Drain Diode, Forward Voltage ^{1), 2)} $V_{GS} = 0V$, $I_S = 45A$	V _{SD}	-	-	1.4	V
AC Characteristics			•		
Turn-on Delay Time V _{DD} = 50% V _{DS} , I _D = 29A, R _G = 4.7Ω	t _{d(ON)}	-	25	50	ns
Rise Time V_{DD} = 50% V_{DS} , I_D = 29A, R_G = 4.7 Ω	t _r	-	20	95	ns
Turn-off Delay Time V_{DD} = 50% V_{DS} , I_D = 29A, R_G = 4.7 Ω	$t_{d(OFF)}$	-	55	80	ns
Fall Time V_{DD} = 50% V_{DS} , I_{D} = 29A, R_{G} = 4.7 Ω	t _f	-	7	75	ns
Reverse Recovery Time V _{DD} < 50% V _{DS} , I _D = 45A	t _{rr}	-	530	600	ns
Common Source Input Capacitance $V_{DS} = 100V, V_{GS} = 0V, f = 1.0MHz$	C _{iss}	3.5	-	6.5	nF
Common Source Output Capacitance $V_{DS} = 100V, V_{GS} = 0V, f = 1.0MHz$	C _{oss}	250	-	400	pF
Common Source Reverse Transfer Capacitance V _{DS} = 100V, V _{GS} = 0V, f = 1.0MHz	C _{rss}	5	-	20	pF
Total Gate Charge $V_{DD} = 50\% V_{DS}, V_{GS} = 10V, I_D = 45A$	Q _G	-	70	100	nC

Notes.: 1) Pulsed Measurement: Pulse Width < 300µs, Duty Cycle <2.0%. 2) Measured within 2.0 mm of case.



Electrical Characteristics

at T_A=125°C; unless otherwise specified

Parameter	Symbol	Values		Unit	
		min.	max.		
DC Characteristics					
Gate Threshold Voltage $I_D = 1.0 \text{mA}, V_{DS} \ge V_{GS}$	V _{GS(th)}	1.5	-	V	
Gate to Source Leakage Current $V_{DS} = 0V, V_{GS} = +/-20V$	I _{GSS}	-	+/-200	nA	
Drain Current $V_{DS} = 200V, V_{GS} = 0V$	I _{DSS}	-	250	μA	
Drain Source On Resistance ¹⁾ $V_{GS} = 10V, I_D = 29A$	r _{DS(ON)}	-	0.09	Ω	

Notes.: 1) Pulsed Measurement: Pulse Width < 300µs, Duty Cycle <2.0%.

Electrical Characteristics

at T_A=-55°C; unless otherwise specified

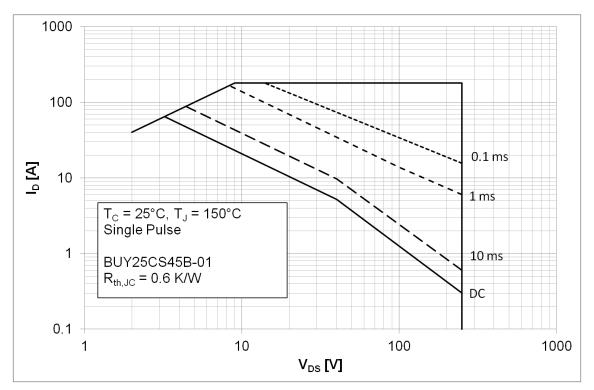
Parameter	Symbol	Values		Unit		
		min.	max.			
DC Characteristics						
Gate Threshold Voltage $I_D = 1.0 \text{mA}, V_{DS} \ge V_{GS}$	V _{GS(th)}	-	5.0	V		



Data Sheet BUY25CS45B-01

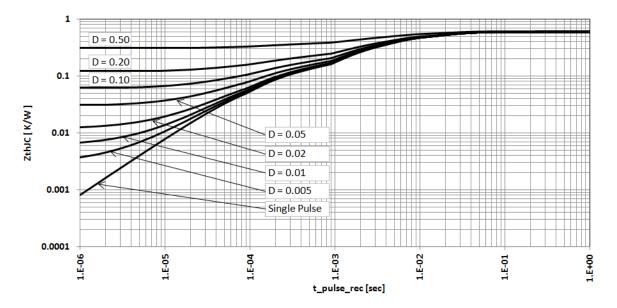
1 Safe operating area

 $I_D = f(V_{DS}); T_C = 25^{\circ}C$ parameter: t_p



2 Max. transient thermal impedance

 $Z_{thJC} = f(t_p)$ parameter: D = t_p/T



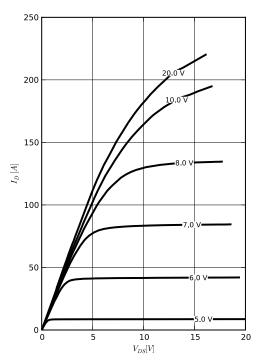


Data Sheet

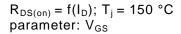
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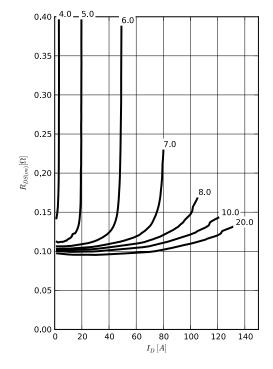
3 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25 \ ^{\circ}C$ parameter: V_{GS}



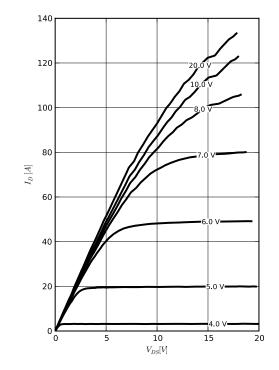
5 Typ. drain-source on-state resistance





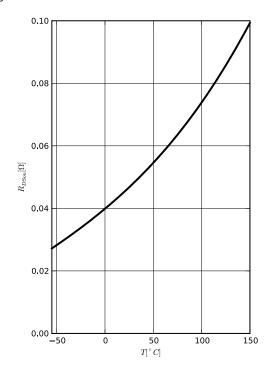
4 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 150 \text{ °C}$ parameter: V_G



6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j)$ I_D=29A



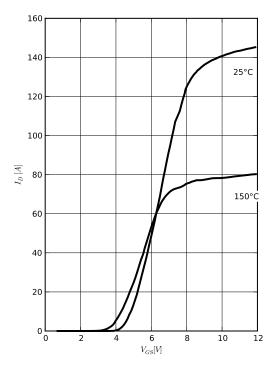


Data Sheet

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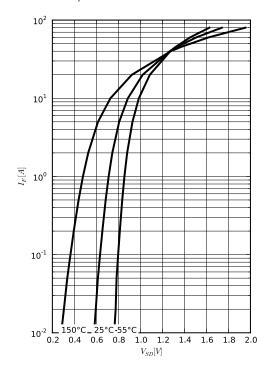
7 Typ. transfer characteristics

 $I_D = f(V_{GS}); |VDS| > 2 |I_D| R_{DS(on)max}$ parameter: T_i



9 Typ. forward characteristics of reverse diode

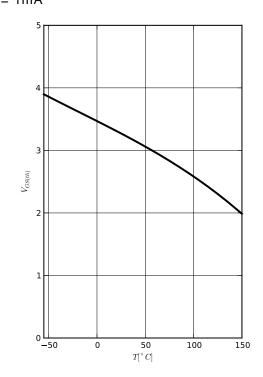
 $I_F = f(V_{SD})$ parameter: T_i



8 Typ. gate threshold voltage

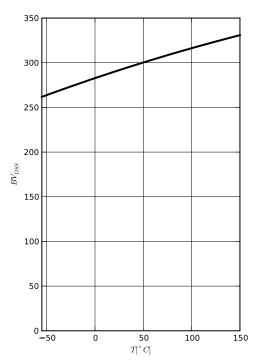
$$I_D = f(T_j)$$

 $I_D = 1mA$



10 Typ. drain-source breakdown voltage

 $BV_{DSS} = f(T_j)$ $I_D = 250 \mu A$



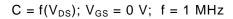
IFAG PMM RFS D HIR

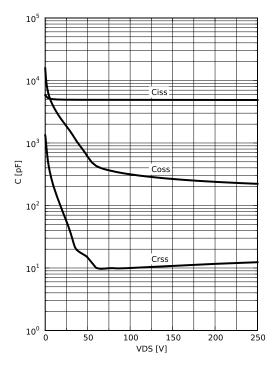


Data Sheet

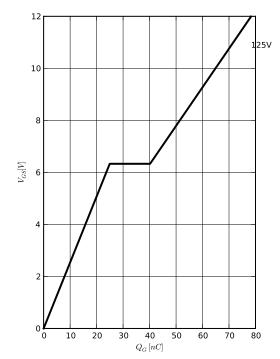
BUY25CS45B-01 12 Typ. gate charge

11 Typ. capacitances



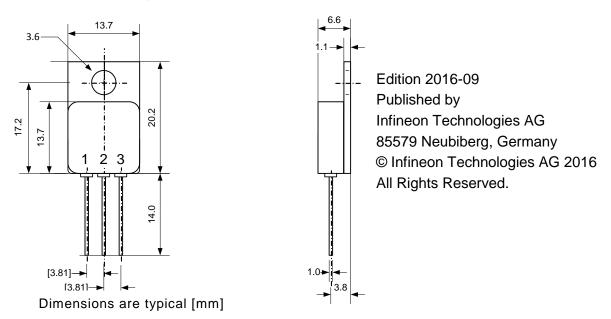


 $V_{GS} = f(Q_{gate}); ID = 45.0 A pulsed parameter: V_{DD}$





TO-254AA Package



Caution

This package contains beryllia. Therefore it must not be in any form machined, grinded, sanded, polished or any other mechanical operation which will produce dust and particles.

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